

Global Physical Vapor Deposition Equipment for SiC and GaN Market 2026 by Manufacturers, Regions, Type and Application, Forecast to 2032

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Abstracts

According to our (Global Info Research) latest study, the global Physical Vapor Deposition Equipment for SiC and GaN market size was valued at US\$ 1313 million in 2025 and is forecast to a readjusted size of US\$ 2371 million by 2032 with a CAGR of 7.4% during review period.

In 2025, global Physical Vapor Deposition Equipment for SiC and GaN production reached approximately 1,215 units with average price of 1.05 million USD/Unit .

Physical Vapor Deposition Equipment for SiC and GaN refers to vacuum thin-film deposition systems used in the fabrication of silicon carbide and gallium nitride semiconductor devices, where materials are physically transferred from solid or vapor sources and deposited onto device wafers to form functional thin films. The equipment is primarily used for frontside metallization, backside metallization, ohmic and Schottky contacts, gate and interconnect metals, barrier or seed layers, carbon protective layers and other functional films required in SiC and GaN device processing. Typical systems integrate high-vacuum process chambers, sputtering or evaporation sources, wafer handling, pre-clean and thermal-conditioning modules, process control and automation. Core specifications include supported wafer diameter, film uniformity, deposition rate, particle performance, vacuum level, wafer temperature capability, film stress and production throughput. This study classifies Physical Vapor Deposition Equipment for SiC and GaN by deposition technology into Magnetron Sputtering PVD Equipment, Ionized PVD Equipment, Evaporation PVD Equipment and Other PVD Equipment, with applications primarily in SiC MOSFETs, SiC diodes, GaN HEMTs, GaN power devices, GaN RF devices and associated compound-semiconductor R&D and production lines.

Key Findings

Magnetron sputtering represents the principal PVD technology route for metallization and functional thin-film formation in SiC and GaN device manufacturing

SiC power-device manufacturing is driving demand for specialized wafer handling backside metallization contact formation and carbon protective-layer deposition

GaN PVD applications are extending from conventional metallization toward contacts functional layers and emerging sputtered compound-semiconductor films

Equipment competition increasingly centers on process stability film uniformity wafer handling productivity and integration of multiple vacuum process modules

Market Trends

Physical Vapor Deposition Equipment for SiC and GaN is evolving from adapted semiconductor PVD platforms toward process architectures specifically optimized for wide-bandgap semiconductor manufacturing. SiC production creates distinctive requirements associated with transparent or semi-transparent wafer handling, wafer bow, thinner processed wafers, backside metallization, high-temperature process compatibility and carbon protection following implantation, while GaN devices require tightly controlled contact metals, gate structures, seed layers and other functional films. Applied Materials has enhanced Endura wafer handling for transparent SiC wafers, KLA's SPTS Sigma PVD platform addresses metal deposition for power devices, ULVAC offers dedicated sputtering and evaporation systems within its SiC process portfolio, and Evatec explicitly develops PVD technologies for both SiC and GaN power devices. The broader technology direction is toward cluster-based vacuum integration, lower contamination, tighter film-stress control and greater flexibility in frontside and backside processing. For GaN, PVD is also expanding beyond conventional metal deposition, with development work involving sputtered GaN and lattice-matching or seed-layer processes, indicating potential for PVD to participate in a broader portion of future compound-semiconductor thin-film stacks.

Market Dynamics

Drivers

The major demand driver is the continuing industrialization of SiC and GaN power and RF semiconductor manufacturing. SiC devices require multiple metal and functional-film deposition steps across frontside contacts, backside structures and related interfaces, while increasing wafer diameters and higher-volume production raise requirements for repeatability, automated wafer handling and throughput. KLA describes PVD as an important process for thick frontside conductor layers and multilayer backside metallization in power semiconductor devices, while Evatec positions PVD systems for high-volume production of power transistors and diodes. GaN adds another growth dimension through power electronics and RF applications, where contact formation and other specialized thin films must be deposited with tight control over composition, stress and interface quality. The movement of wide-bandgap devices from specialty production toward increasingly standardized manufacturing therefore supports investment in production-grade PVD platforms rather than laboratory deposition tools alone.

Restraints

Physical Vapor Deposition Equipment for SiC and GaN faces relatively high equipment and process-development barriers. Wide-bandgap wafers can present handling characteristics that differ from conventional silicon, and device performance is sensitive to contact resistance, film adhesion, stress, contamination and thermal history. Process chambers, targets, wafer handling and pre-treatment modules must therefore be optimized around individual film stacks and device architectures, increasing qualification time and engineering cost. Production equipment also requires high vacuum reliability, particle control, preventive maintenance and stable target utilization over long manufacturing cycles. In addition, PVD competes with alternative deposition technologies for selected functional films, meaning the addressable process share depends on material requirements and device design rather than simply on growth in SiC and GaN wafer output.

Opportunities

The most attractive opportunities are associated with expanding SiC wafer production, increasing device complexity and the extension of PVD into additional GaN functional films. SiC manufacturing increasingly requires specialized backside metal stacks,

frontside contact layers and carbon capping or protective deposition, creating opportunities for dedicated modules and multi-chamber platforms. Evatec explicitly identifies PVD solutions for metals, contacts, piezoelectrics and dielectrics in SiC and GaN power devices, while ULVAC combines sputtering and evaporation systems within its power-device process portfolio. For GaN, emerging sputter-based deposition of GaN and lattice-matching or seed layers could broaden the role of PVD beyond metallization if manufacturing performance and economics continue to improve. Another opportunity lies in integrating pre-clean, heating, cooling and multiple deposition modules within cluster architectures, reducing atmospheric exposure between critical process steps and enabling equipment suppliers to capture more value per manufacturing line.

Challenges

The central challenge is converting technically feasible PVD processes into stable, high-yield production recipes across increasingly demanding SiC and GaN device structures. Film thickness, composition, interface cleanliness and stress must remain tightly controlled across the wafer and from lot to lot, while power-device wafers can introduce additional challenges associated with bow, thinning and backside processing. Equipment makers must also support evolving wafer diameters without compromising yield or productivity. In GaN, the range of competing deposition approaches and the diversity of RF and power-device architectures create additional uncertainty regarding which functional layers will ultimately migrate toward sputtering or other PVD methods. Suppliers therefore need strong process-development capability in addition to vacuum-equipment engineering, while customers increasingly evaluate equipment based on demonstrated device-level results, uptime, service response and production economics rather than nominal deposition specifications alone.

Industry Chain Analysis

The upstream industry chain for Physical Vapor Deposition Equipment for SiC and GaN includes vacuum chambers, vacuum pumps, valves, mass-flow and pressure-control components, sputtering cathodes, evaporation sources, RF and DC power supplies, targets and evaporation materials, heaters, electrostatic or mechanical wafer chucks, wafer-transfer robots, sensors and process-control electronics. Semiconductor-grade metal and compound targets are critical consumables because purity, microstructure and target utilization affect film quality and operating cost. The increasing use of cluster architectures also raises the importance of transfer chambers, load locks, pre-clean

modules and integrated vacuum-control systems. KLA's Sigma platform supports integration of pretreatment with PVD within a cluster environment, while ULVAC offers multi-chamber platforms capable of combining PVD with heating, cooling and pre-clean functionality.

Midstream equipment manufacturers create value through vacuum-system design, process-source engineering, wafer handling, film-uniformity control, recipe development and integration of multiple deposition and pretreatment steps. Downstream customers are SiC and GaN wafer fabs, integrated device manufacturers, foundries, compound-semiconductor producers and R&D or pilot facilities. The economic value of equipment is strongly linked to process qualification and installed-base support because customers require stable recipes, spare parts, chamber maintenance and target-management services throughout production. As SiC and GaN manufacturing scales, competitive advantage increasingly depends on the ability to combine equipment reliability with device-specific process expertise and global field-service capability.

Segment Insights

By deposition technology, the Physical Vapor Deposition Equipment for SiC and GaN market is classified into Magnetron Sputtering PVD Equipment, Ionized PVD Equipment, Evaporation PVD Equipment and Other PVD Equipment. Magnetron sputtering forms the broadest technology base because it supports controlled deposition of metals and other functional materials with high uniformity and compatibility with automated semiconductor manufacturing. Production sputtering platforms are widely used for frontside and backside metallization, contact layers, UBM-related structures and other device films. ULVAC's power-device portfolio includes dedicated sputtering systems, while KLA's Sigma PVD platform deposits conductive and insulating layers for semiconductor and power-device applications.

Ionized PVD provides additional control over incoming material flux and step coverage and is valuable where device structures require enhanced bottom or sidewall coverage and lower-temperature processing. Applied Materials' high-ionization PVD technologies illustrate the role of plasma-assisted control in advanced metal deposition. Evaporation remains relevant for selected metal stacks and compound-semiconductor processes where material characteristics, deposition rate or film requirements favor thermal or electron-beam evaporation. The technology mix therefore reflects individual device structures rather than a single universal deposition method, although sputtering remains the most broadly applicable route across SiC and GaN manufacturing.

Downstream Market Opportunities

SiC power devices represent one of the clearest downstream opportunities for Physical Vapor Deposition Equipment for SiC and GaN because MOSFETs, Schottky diodes and related devices require multiple contact and metallization steps, including specialized backside processes. Applied Materials, Evatec, KLA/SPTS and ULVAC have all developed PVD capabilities relevant to power-device processing, demonstrating the increasing equipment intensity of this manufacturing segment. GaN power devices and GaN RF devices provide another opportunity through ohmic contacts, gate metallization and functional-film requirements, while emerging sputtered GaN processes could create additional equipment demand if adopted in production. R&D and pilot lines remain commercially relevant because wide-bandgap semiconductor manufacturers continue to develop new materials, contact schemes and device structures before transferring processes into high-volume manufacturing.

Regional Insights

Asia-Pacific is a strategically important manufacturing region for Physical Vapor Deposition Equipment for SiC and GaN because the region combines significant semiconductor equipment manufacturing capabilities with expanding SiC and GaN device investment. Japan maintains established vacuum and semiconductor-equipment expertise through suppliers such as ULVAC and Canon Anelva, while China has developed domestic PVD equipment capabilities through confirmed suppliers including NAURA, Guangdong Huicheng Vacuum and SJI-SEMI. Taiwan's Skytech also participates in compound-semiconductor PVD equipment. This regional supplier expansion is increasing localization opportunities for wide-bandgap semiconductor production lines while raising competition around cost, delivery lead times and domestic technical support.

North America and Europe maintain strong positions in high-end process equipment and process development. Applied Materials and KLA/SPTS provide semiconductor-scale deposition platforms, while Evatec and Plasma-Therm contribute specialized compound-semiconductor and power-device capabilities. Evatec explicitly addresses SiC and GaN power-device PVD, including emerging GaN deposition processes, demonstrating Europe's continuing role in advanced thin-film development. Regional competition therefore differs in emphasis: North American and European suppliers

generally benefit from process expertise and established semiconductor installed bases, while Asian suppliers increasingly combine local manufacturing, customer proximity and expanding wide-bandgap semiconductor ecosystems.

Competitive Landscape Analysis

The competitive landscape of Physical Vapor Deposition Equipment for SiC and GaN combines large semiconductor capital-equipment companies, established vacuum-technology groups and specialized PVD suppliers. Applied Materials and KLA/SPTS participate through semiconductor-grade PVD platforms and broad installed-base process expertise; Evatec has developed a focused position in thin-film technologies for SiC and GaN power devices; ULVAC combines sputtering, evaporation and other process equipment within a broad power-device portfolio. NAURA, Guangdong Huicheng Vacuum, SJI-SEMI and Skytech broaden the Asian supplier base, while KDF Technologies, PVD Products and Plasma-Therm represent more specialized equipment approaches. Canon Anelva also contributes established semiconductor sputtering capability. Competition is increasingly determined by the ability to handle wide-bandgap wafers reliably, qualify application-specific film stacks, maintain low particles and stable film properties, integrate frontside and backside processes and support customers during production ramps. Large semiconductor-equipment groups benefit from process integration, installed-base service and manufacturing scale, whereas specialist suppliers can differentiate through application flexibility, customized chamber configurations and faster development around specific SiC or GaN processes. As device manufacturing matures, sustained differentiation is likely to depend more on production yield, uptime, process repeatability and total cost of ownership than on basic PVD availability.

Report Scope

This report is a detailed and comprehensive analysis for global Physical Vapor Deposition Equipment for SiC and GaN market. Both quantitative and qualitative analyses are presented by manufacturers, by region & country, by Type and by Application. As the market is constantly changing, this report explores the competition, supply and demand trends, as well as key factors that contribute to its changing demands across many markets. Company profiles and product examples of selected competitors, along with market share estimates of some of the selected leaders for the year 2025, are provided.

Key Features:

Global Physical Vapor Deposition Equipment for SiC and GaN market size and forecasts, in consumption value (\$ Million), sales quantity (Units), and average selling prices (K US\$/Unit), 2021-2032

Global Physical Vapor Deposition Equipment for SiC and GaN market size and forecasts by region and country, in consumption value (\$ Million), sales quantity (Units), and average selling prices (K US\$/Unit), 2021-2032

Global Physical Vapor Deposition Equipment for SiC and GaN market size and forecasts, by Type and by Application, in consumption value (\$ Million), sales quantity (Units), and average selling prices (K US\$/Unit), 2021-2032

Global Physical Vapor Deposition Equipment for SiC and GaN market shares of main players, shipments in revenue (\$ Million), sales quantity (Units), and ASP (K US\$/Unit), 2021-2026

The Primary Objectives in This Report Are:

To determine the size of the total market opportunity of global and key countries

To assess the growth potential for Physical Vapor Deposition Equipment for SiC and GaN

To forecast future growth in each product and end-use market

To assess competitive factors affecting the marketplace

This report profiles key players in the global Physical Vapor Deposition Equipment for SiC and GaN market based on the following parameters - company overview, sales quantity, revenue, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include Applied Materials, Inc., Evatec AG, KLA Corporation (SPTS Technologies), NAURA Technology Group Co., Ltd., Guangdong Huicheng Vacuum Technology Co., Ltd., Canon Anelva

Corporation, ULVAC, Inc., KDF Technologies, PVD Products, Inc., SJI-SEMI Co., Ltd., etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals.

Physical Vapor Deposition Equipment for SiC and GaN market is split by Type and by Application. For the period 2021-2032, the growth among segments provides accurate calculations and forecasts for consumption value by Type, and by Application in terms of volume and value. This analysis can help you expand your business by targeting qualified niche markets.

Market Segmentation

Market segment by Type

Magnetron Sputtering Systems

Evaporation PVD Systems

Ion-Beam and HiPIMS Systems

Hybrid PVD Systems

Others

Market segment by Wafer Size

Wafer Size 150 mm and Below

200 mm Wafer Systems

300 mm Wafer Systems

Multi-Size Flexible Systems

Others

Market segment by Structure

Cluster PVD Systems

Standalone PVD Systems

In-Line PVD Systems

Market segment by Application

SiC Devices

GaN Devices

Major players covered

Applied Materials, Inc.

Evatec AG

KLA Corporation (SPTS Technologies)

NAURA Technology Group Co., Ltd.

Guangdong Huicheng Vacuum Technology Co., Ltd.

Canon Anelva Corporation

ULVAC, Inc.

KDF Technologies

PVD Products, Inc.

SJI-SEMI Co., Ltd.

Skytech Inc.

Plasma-Therm LLC

Market segment by region, regional analysis covers

North America (United States, Canada, and Mexico)

Europe (Germany, France, United Kingdom, Russia, Italy, and Rest of Europe)

Asia-Pacific (China, Japan, Korea, India, Southeast Asia, and Australia)

South America (Brazil, Argentina, Colombia, and Rest of South America)

Middle East & Africa (Saudi Arabia, UAE, Egypt, South Africa, and Rest of Middle East & Africa)

Chapter Outline

Chapter 1, to describe Physical Vapor Deposition Equipment for SiC and GaN product scope, market overview, market estimation caveats and base year.

Chapter 2, to profile the top manufacturers of Physical Vapor Deposition Equipment for SiC and GaN, with price, sales quantity, revenue, and global market share of Physical Vapor Deposition Equipment for SiC and GaN from 2021 to 2026.

Chapter 3, the Physical Vapor Deposition Equipment for SiC and GaN competitive situation, sales quantity, revenue, and global market share of top manufacturers are analyzed emphatically by landscape contrast.

Chapter 4, the Physical Vapor Deposition Equipment for SiC and GaN breakdown data are shown at the regional level, to show the sales quantity, consumption value, and growth by regions, from 2021 to 2032.

Chapter 5 and 6, to segment the sales by Type and by Application, with sales market share and growth rate by Type, by Application, from 2021 to 2032.

Chapter 7, 8, 9, 10 and 11, to break the sales data at the country level, with sales quantity, consumption value, and market share for key countries in the world, from 2021 to 2026. and Physical Vapor Deposition Equipment for SiC and GaN market forecast, by regions, by Type, and by Application, with sales and revenue, from 2027 to 2032.

Chapter 12, market dynamics, drivers, restraints, trends, and Porters Five Forces analysis.

Chapter 13, the key raw materials and key suppliers, and industry chain of Physical Vapor Deposition Equipment for SiC and GaN.

Chapter 14 and 15, to describe Physical Vapor Deposition Equipment for SiC and GaN sales channel, distributors, customers, research findings and conclusion.

Contents

1 MARKET OVERVIEW

1.1 Product Overview and Scope

1.2 Market Estimation Caveats and Base Year

1.3 Market Analysis by Type

1.3.1 Overview: Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Type: 2021 Versus 2025 Versus 2032

1.3.2 Magnetron Sputtering Systems

1.3.3 Evaporation PVD Systems

1.3.4 Ion-Beam and HiPIMS Systems

1.3.5 Hybrid PVD Systems

1.3.6 Others

1.4 Market Analysis by Wafer Size

1.4.1 Overview: Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Wafer Size: 2021 Versus 2025 Versus 2032

1.4.2 Wafer Size 150 mm and Below

1.4.3 200 mm Wafer Systems

1.4.4 300 mm Wafer Systems

1.4.5 Multi-Size Flexible Systems

1.4.6 Others

1.5 Market Analysis by Structure

1.5.1 Overview: Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Structure: 2021 Versus 2025 Versus 2032

1.5.2 Cluster PVD Systems

1.5.3 Standalone PVD Systems

1.5.4 In-Line PVD Systems

1.6 Market Analysis by Application

1.6.1 Overview: Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Application: 2021 Versus 2025 Versus 2032

1.6.2 SiC Devices

1.6.3 GaN Devices

1.7 Global Physical Vapor Deposition Equipment for SiC and GaN Market Size & Forecast

1.7.1 Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021 & 2025 & 2032)

1.7.2 Global Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity (2021-2032)

1.7.3 Global Physical Vapor Deposition Equipment for SiC and GaN Average Price (2021-2032)

2 MANUFACTURERS PROFILES

2.1 Applied Materials, Inc.

2.1.1 Applied Materials, Inc. Details

2.1.2 Applied Materials, Inc. Major Business

2.1.3 Applied Materials, Inc. Physical Vapor Deposition Equipment for SiC and GaN Product and Services

2.1.4 Applied Materials, Inc. Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)

2.1.5 Applied Materials, Inc. Recent Developments/Updates

2.2 Evatec AG

2.2.1 Evatec AG Details

2.2.2 Evatec AG Major Business

2.2.3 Evatec AG Physical Vapor Deposition Equipment for SiC and GaN Product and Services

2.2.4 Evatec AG Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)

2.2.5 Evatec AG Recent Developments/Updates

2.3 KLA Corporation (SPTS Technologies)

2.3.1 KLA Corporation (SPTS Technologies) Details

2.3.2 KLA Corporation (SPTS Technologies) Major Business

2.3.3 KLA Corporation (SPTS Technologies) Physical Vapor Deposition Equipment for SiC and GaN Product and Services

2.3.4 KLA Corporation (SPTS Technologies) Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)

2.3.5 KLA Corporation (SPTS Technologies) Recent Developments/Updates

2.4 NAURA Technology Group Co., Ltd.

2.4.1 NAURA Technology Group Co., Ltd. Details

2.4.2 NAURA Technology Group Co., Ltd. Major Business

2.4.3 NAURA Technology Group Co., Ltd. Physical Vapor Deposition Equipment for SiC and GaN Product and Services

2.4.4 NAURA Technology Group Co., Ltd. Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)

2.4.5 NAURA Technology Group Co., Ltd. Recent Developments/Updates

2.5 Guangdong Huicheng Vacuum Technology Co., Ltd.

2.5.1 Guangdong Huicheng Vacuum Technology Co., Ltd. Details

2.5.2 Guangdong Huicheng Vacuum Technology Co., Ltd. Major Business

2.5.3 Guangdong Huicheng Vacuum Technology Co., Ltd. Physical Vapor Deposition Equipment for SiC and GaN Product and Services

2.5.4 Guangdong Huicheng Vacuum Technology Co., Ltd. Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)

2.5.5 Guangdong Huicheng Vacuum Technology Co., Ltd. Recent Developments/Updates

2.6 Canon Anelva Corporation

2.6.1 Canon Anelva Corporation Details

2.6.2 Canon Anelva Corporation Major Business

2.6.3 Canon Anelva Corporation Physical Vapor Deposition Equipment for SiC and GaN Product and Services

2.6.4 Canon Anelva Corporation Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)

2.6.5 Canon Anelva Corporation Recent Developments/Updates

2.7 ULVAC, Inc.

2.7.1 ULVAC, Inc. Details

2.7.2 ULVAC, Inc. Major Business

2.7.3 ULVAC, Inc. Physical Vapor Deposition Equipment for SiC and GaN Product and Services

2.7.4 ULVAC, Inc. Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)

2.7.5 ULVAC, Inc. Recent Developments/Updates

2.8 KDF Technologies

2.8.1 KDF Technologies Details

2.8.2 KDF Technologies Major Business

2.8.3 KDF Technologies Physical Vapor Deposition Equipment for SiC and GaN Product and Services

2.8.4 KDF Technologies Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)

2.8.5 KDF Technologies Recent Developments/Updates

2.9 PVD Products, Inc.

2.9.1 PVD Products, Inc. Details

2.9.2 PVD Products, Inc. Major Business

2.9.3 PVD Products, Inc. Physical Vapor Deposition Equipment for SiC and GaN

Product and Services

2.9.4 PVD Products, Inc. Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)

2.9.5 PVD Products, Inc. Recent Developments/Updates

2.10 SJI-SEMI Co., Ltd.

2.10.1 SJI-SEMI Co., Ltd. Details

2.10.2 SJI-SEMI Co., Ltd. Major Business

2.10.3 SJI-SEMI Co., Ltd. Physical Vapor Deposition Equipment for SiC and GaN

Product and Services

2.10.4 SJI-SEMI Co., Ltd. Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)

2.10.5 SJI-SEMI Co., Ltd. Recent Developments/Updates

2.11 Skytech Inc.

2.11.1 Skytech Inc. Details

2.11.2 Skytech Inc. Major Business

2.11.3 Skytech Inc. Physical Vapor Deposition Equipment for SiC and GaN Product and Services

2.11.4 Skytech Inc. Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)

2.11.5 Skytech Inc. Recent Developments/Updates

2.12 Plasma-Therm LLC

2.12.1 Plasma-Therm LLC Details

2.12.2 Plasma-Therm LLC Major Business

2.12.3 Plasma-Therm LLC Physical Vapor Deposition Equipment for SiC and GaN

Product and Services

2.12.4 Plasma-Therm LLC Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity, Average Price, Revenue, Gross Margin and Market Share (2021-2026)

2.12.5 Plasma-Therm LLC Recent Developments/Updates

3 COMPETITIVE ENVIRONMENT: PHYSICAL VAPOR DEPOSITION EQUIPMENT FOR SiC AND GAN BY MANUFACTURER

3.1 Global Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Manufacturer (2021-2026)

3.2 Global Physical Vapor Deposition Equipment for SiC and GaN Revenue by Manufacturer (2021-2026)

3.3 Global Physical Vapor Deposition Equipment for SiC and GaN Average Price by Manufacturer (2021-2026)

3.4 Market Share Analysis (2025)

3.4.1 Producer Shipments of Physical Vapor Deposition Equipment for SiC and GaN by Manufacturer Revenue (\$MM) and Market Share (%): 2025

3.4.2 Top 3 Physical Vapor Deposition Equipment for SiC and GaN Manufacturer Market Share in 2025

3.4.3 Top 6 Physical Vapor Deposition Equipment for SiC and GaN Manufacturer Market Share in 2025

3.5 Physical Vapor Deposition Equipment for SiC and GaN Market: Overall Company Footprint Analysis

3.5.1 Physical Vapor Deposition Equipment for SiC and GaN Market: Region Footprint

3.5.2 Physical Vapor Deposition Equipment for SiC and GaN Market: Company Product Type Footprint

3.5.3 Physical Vapor Deposition Equipment for SiC and GaN Market: Company Product Application Footprint

3.6 New Market Entrants and Barriers to Market Entry

3.7 Mergers, Acquisition, Agreements, and Collaborations

4 CONSUMPTION ANALYSIS BY REGION

4.1 Global Physical Vapor Deposition Equipment for SiC and GaN Market Size by Region

4.1.1 Global Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Region (2021-2032)

4.1.2 Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Region (2021-2032)

4.1.3 Global Physical Vapor Deposition Equipment for SiC and GaN Average Price by Region (2021-2032)

4.2 North America Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032)

4.3 Europe Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032)

4.4 Asia-Pacific Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032)

4.5 South America Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032)

4.6 Middle East & Africa Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032)

5 MARKET SEGMENT BY TYPE

5.1 Global Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Type (2021-2032)

5.2 Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Type (2021-2032)

5.3 Global Physical Vapor Deposition Equipment for SiC and GaN Average Price by Type (2021-2032)

6 MARKET SEGMENT BY APPLICATION

6.1 Global Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Application (2021-2032)

6.2 Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Application (2021-2032)

6.3 Global Physical Vapor Deposition Equipment for SiC and GaN Average Price by Application (2021-2032)

7 NORTH AMERICA

7.1 North America Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Type (2021-2032)

7.2 North America Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Application (2021-2032)

7.3 North America Physical Vapor Deposition Equipment for SiC and GaN Market Size by Country

7.3.1 North America Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Country (2021-2032)

7.3.2 North America Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Country (2021-2032)

7.3.3 United States Market Size and Forecast (2021-2032)

7.3.4 Canada Market Size and Forecast (2021-2032)

7.3.5 Mexico Market Size and Forecast (2021-2032)

8 EUROPE

8.1 Europe Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Type (2021-2032)

8.2 Europe Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Application (2021-2032)

8.3 Europe Physical Vapor Deposition Equipment for SiC and GaN Market Size by

Country

8.3.1 Europe Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Country (2021-2032)

8.3.2 Europe Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Country (2021-2032)

8.3.3 Germany Market Size and Forecast (2021-2032)

8.3.4 France Market Size and Forecast (2021-2032)

8.3.5 United Kingdom Market Size and Forecast (2021-2032)

8.3.6 Russia Market Size and Forecast (2021-2032)

8.3.7 Italy Market Size and Forecast (2021-2032)

9 ASIA-PACIFIC

9.1 Asia-Pacific Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Type (2021-2032)

9.2 Asia-Pacific Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Application (2021-2032)

9.3 Asia-Pacific Physical Vapor Deposition Equipment for SiC and GaN Market Size by Region

9.3.1 Asia-Pacific Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Region (2021-2032)

9.3.2 Asia-Pacific Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Region (2021-2032)

9.3.3 China Market Size and Forecast (2021-2032)

9.3.4 Japan Market Size and Forecast (2021-2032)

9.3.5 South Korea Market Size and Forecast (2021-2032)

9.3.6 India Market Size and Forecast (2021-2032)

9.3.7 Southeast Asia Market Size and Forecast (2021-2032)

9.3.8 Australia Market Size and Forecast (2021-2032)

10 SOUTH AMERICA

10.1 South America Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Type (2021-2032)

10.2 South America Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Application (2021-2032)

10.3 South America Physical Vapor Deposition Equipment for SiC and GaN Market Size by Country

10.3.1 South America Physical Vapor Deposition Equipment for SiC and GaN Sales

Quantity by Country (2021-2032)

10.3.2 South America Physical Vapor Deposition Equipment for SiC and GaN

Consumption Value by Country (2021-2032)

10.3.3 Brazil Market Size and Forecast (2021-2032)

10.3.4 Argentina Market Size and Forecast (2021-2032)

11 MIDDLE EAST & AFRICA

11.1 Middle East & Africa Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Type (2021-2032)

11.2 Middle East & Africa Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Application (2021-2032)

11.3 Middle East & Africa Physical Vapor Deposition Equipment for SiC and GaN Market Size by Country

11.3.1 Middle East & Africa Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Country (2021-2032)

11.3.2 Middle East & Africa Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Country (2021-2032)

11.3.3 Turkey Market Size and Forecast (2021-2032)

11.3.4 Egypt Market Size and Forecast (2021-2032)

11.3.5 Saudi Arabia Market Size and Forecast (2021-2032)

11.3.6 South Africa Market Size and Forecast (2021-2032)

12 MARKET DYNAMICS

12.1 Physical Vapor Deposition Equipment for SiC and GaN Market Drivers

12.2 Physical Vapor Deposition Equipment for SiC and GaN Market Restraints

12.3 Physical Vapor Deposition Equipment for SiC and GaN Trends Analysis

12.4 Porters Five Forces Analysis

12.4.1 Threat of New Entrants

12.4.2 Bargaining Power of Suppliers

12.4.3 Bargaining Power of Buyers

12.4.4 Threat of Substitutes

12.4.5 Competitive Rivalry

13 RAW MATERIAL AND INDUSTRY CHAIN

13.1 Raw Material of Physical Vapor Deposition Equipment for SiC and GaN and Key Manufacturers

13.2 Manufacturing Costs Percentage of Physical Vapor Deposition Equipment for SiC and GaN

13.3 Physical Vapor Deposition Equipment for SiC and GaN Production Process

13.4 Industry Value Chain Analysis

14 SHIPMENTS BY DISTRIBUTION CHANNEL

14.1 Sales Channel

14.1.1 Direct to End-User

14.1.2 Distributors

14.2 Physical Vapor Deposition Equipment for SiC and GaN Typical Distributors

14.3 Physical Vapor Deposition Equipment for SiC and GaN Typical Customers

15 RESEARCH FINDINGS AND CONCLUSION

16 APPENDIX

16.1 Methodology

16.2 Research Process and Data Source

16.3 Disclaimer

List Of Tables

LIST OF TABLES

Table 1. Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Type, (USD Million), 2021 & 2025 & 2032

Table 2. Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Wafer Size, (USD Million), 2021 & 2025 & 2032

Table 3. Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Structure, (USD Million), 2021 & 2025 & 2032

Table 4. Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Application, (USD Million), 2021 & 2025 & 2032

Table 5. Applied Materials, Inc. Basic Information, Manufacturing Base and Competitors

Table 6. Applied Materials, Inc. Major Business

Table 7. Applied Materials, Inc. Physical Vapor Deposition Equipment for SiC and GaN Product and Services

Table 8. Applied Materials, Inc. Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity (Units), Average Price (K US\$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)

Table 9. Applied Materials, Inc. Recent Developments/Updates

Table 10. Evatec AG Basic Information, Manufacturing Base and Competitors

Table 11. Evatec AG Major Business

Table 12. Evatec AG Physical Vapor Deposition Equipment for SiC and GaN Product and Services

Table 13. Evatec AG Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity (Units), Average Price (K US\$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)

Table 14. Evatec AG Recent Developments/Updates

Table 15. KLA Corporation (SPTS Technologies) Basic Information, Manufacturing Base and Competitors

Table 16. KLA Corporation (SPTS Technologies) Major Business

Table 17. KLA Corporation (SPTS Technologies) Physical Vapor Deposition Equipment for SiC and GaN Product and Services

Table 18. KLA Corporation (SPTS Technologies) Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity (Units), Average Price (K US\$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)

Table 19. KLA Corporation (SPTS Technologies) Recent Developments/Updates

Table 20. NAURA Technology Group Co., Ltd. Basic Information, Manufacturing Base and Competitors

Table 21. NAURA Technology Group Co., Ltd. Major Business

Table 22. NAURA Technology Group Co., Ltd. Physical Vapor Deposition Equipment for SiC and GaN Product and Services

Table 23. NAURA Technology Group Co., Ltd. Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity (Units), Average Price (K US\$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)

Table 24. NAURA Technology Group Co., Ltd. Recent Developments/Updates

Table 25. Guangdong Huicheng Vacuum Technology Co., Ltd. Basic Information, Manufacturing Base and Competitors

Table 26. Guangdong Huicheng Vacuum Technology Co., Ltd. Major Business

Table 27. Guangdong Huicheng Vacuum Technology Co., Ltd. Physical Vapor Deposition Equipment for SiC and GaN Product and Services

Table 28. Guangdong Huicheng Vacuum Technology Co., Ltd. Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity (Units), Average Price (K US\$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)

Table 29. Guangdong Huicheng Vacuum Technology Co., Ltd. Recent Developments/Updates

Table 30. Canon Anelva Corporation Basic Information, Manufacturing Base and Competitors

Table 31. Canon Anelva Corporation Major Business

Table 32. Canon Anelva Corporation Physical Vapor Deposition Equipment for SiC and GaN Product and Services

Table 33. Canon Anelva Corporation Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity (Units), Average Price (K US\$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)

Table 34. Canon Anelva Corporation Recent Developments/Updates

Table 35. ULVAC, Inc. Basic Information, Manufacturing Base and Competitors

Table 36. ULVAC, Inc. Major Business

Table 37. ULVAC, Inc. Physical Vapor Deposition Equipment for SiC and GaN Product and Services

Table 38. ULVAC, Inc. Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity (Units), Average Price (K US\$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)

Table 39. ULVAC, Inc. Recent Developments/Updates

Table 40. KDF Technologies Basic Information, Manufacturing Base and Competitors

Table 41. KDF Technologies Major Business

Table 42. KDF Technologies Physical Vapor Deposition Equipment for SiC and GaN Product and Services

Table 43. KDF Technologies Physical Vapor Deposition Equipment for SiC and GaN

Sales Quantity (Units), Average Price (K US\$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)

Table 44. KDF Technologies Recent Developments/Updates

Table 45. PVD Products, Inc. Basic Information, Manufacturing Base and Competitors

Table 46. PVD Products, Inc. Major Business

Table 47. PVD Products, Inc. Physical Vapor Deposition Equipment for SiC and GaN Product and Services

Table 48. PVD Products, Inc. Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity (Units), Average Price (K US\$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)

Table 49. PVD Products, Inc. Recent Developments/Updates

Table 50. SJI-SEMI Co., Ltd. Basic Information, Manufacturing Base and Competitors

Table 51. SJI-SEMI Co., Ltd. Major Business

Table 52. SJI-SEMI Co., Ltd. Physical Vapor Deposition Equipment for SiC and GaN Product and Services

Table 53. SJI-SEMI Co., Ltd. Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity (Units), Average Price (K US\$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)

Table 54. SJI-SEMI Co., Ltd. Recent Developments/Updates

Table 55. Skytech Inc. Basic Information, Manufacturing Base and Competitors

Table 56. Skytech Inc. Major Business

Table 57. Skytech Inc. Physical Vapor Deposition Equipment for SiC and GaN Product and Services

Table 58. Skytech Inc. Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity (Units), Average Price (K US\$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)

Table 59. Skytech Inc. Recent Developments/Updates

Table 60. Plasma-Therm LLC Basic Information, Manufacturing Base and Competitors

Table 61. Plasma-Therm LLC Major Business

Table 62. Plasma-Therm LLC Physical Vapor Deposition Equipment for SiC and GaN Product and Services

Table 63. Plasma-Therm LLC Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity (Units), Average Price (K US\$/Unit), Revenue (USD Million), Gross Margin and Market Share (2021-2026)

Table 64. Plasma-Therm LLC Recent Developments/Updates

Table 65. Global Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Manufacturer (2021-2026) & (Units)

Table 66. Global Physical Vapor Deposition Equipment for SiC and GaN Revenue by Manufacturer (2021-2026) & (USD Million)

Table 67. Global Physical Vapor Deposition Equipment for SiC and GaN Average Price by Manufacturer (2021-2026) & (K US\$/Unit)

Table 68. Market Position of Manufacturers in Physical Vapor Deposition Equipment for SiC and GaN, (Tier 1, Tier 2, and Tier 3), Based on Revenue in 2025

Table 69. Head Office and Physical Vapor Deposition Equipment for SiC and GaN Production Site of Key Manufacturer

Table 70. Physical Vapor Deposition Equipment for SiC and GaN Market: Company Product Type Footprint

Table 71. Physical Vapor Deposition Equipment for SiC and GaN Market: Company Product Application Footprint

Table 72. Physical Vapor Deposition Equipment for SiC and GaN New Market Entrants and Barriers to Market Entry

Table 73. Physical Vapor Deposition Equipment for SiC and GaN Mergers, Acquisition, Agreements, and Collaborations

Table 74. Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Region (2021-2025-2032) & (USD Million) & CAGR

Table 75. Global Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Region (2021-2026) & (Units)

Table 76. Global Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Region (2027-2032) & (Units)

Table 77. Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Region (2021-2026) & (USD Million)

Table 78. Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Region (2027-2032) & (USD Million)

Table 79. Global Physical Vapor Deposition Equipment for SiC and GaN Average Price by Region (2021-2026) & (K US\$/Unit)

Table 80. Global Physical Vapor Deposition Equipment for SiC and GaN Average Price by Region (2027-2032) & (K US\$/Unit)

Table 81. Global Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Type (2021-2026) & (Units)

Table 82. Global Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Type (2027-2032) & (Units)

Table 83. Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Type (2021-2026) & (USD Million)

Table 84. Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Type (2027-2032) & (USD Million)

Table 85. Global Physical Vapor Deposition Equipment for SiC and GaN Average Price by Type (2021-2026) & (K US\$/Unit)

Table 86. Global Physical Vapor Deposition Equipment for SiC and GaN Average Price

by Type (2027-2032) & (K US\$/Unit)

Table 87. Global Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Application (2021-2026) & (Units)

Table 88. Global Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Application (2027-2032) & (Units)

Table 89. Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Application (2021-2026) & (USD Million)

Table 90. Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Application (2027-2032) & (USD Million)

Table 91. Global Physical Vapor Deposition Equipment for SiC and GaN Average Price by Application (2021-2026) & (K US\$/Unit)

Table 92. Global Physical Vapor Deposition Equipment for SiC and GaN Average Price by Application (2027-2032) & (K US\$/Unit)

Table 93. North America Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Type (2021-2026) & (Units)

Table 94. North America Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Type (2027-2032) & (Units)

Table 95. North America Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Application (2021-2026) & (Units)

Table 96. North America Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Application (2027-2032) & (Units)

Table 97. North America Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Country (2021-2026) & (Units)

Table 98. North America Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Country (2027-2032) & (Units)

Table 99. North America Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Country (2021-2026) & (USD Million)

Table 100. North America Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Country (2027-2032) & (USD Million)

Table 101. Europe Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Type (2021-2026) & (Units)

Table 102. Europe Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Type (2027-2032) & (Units)

Table 103. Europe Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Application (2021-2026) & (Units)

Table 104. Europe Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Application (2027-2032) & (Units)

Table 105. Europe Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity by Country (2021-2026) & (Units)

Table 106. Europe Physical Vapor Deposition Equipment for SiC and GaN Sales
Quantity by Country (2027-2032) & (Units)

Table 107. Europe Physical Vapor Deposition Equipment for SiC and GaN
Consumption Value by Country (2021-2026) & (USD Million)

Table 108. Europe Physical Vapor Deposition Equipment for SiC and GaN
Consumption Value by Country (2027-2032) & (USD Million)

Table 109. Asia-Pacific Physical Vapor Deposition Equipment for SiC and GaN Sales
Quantity by Type (2021-2026) & (Units)

Table 110. Asia-Pacific Physical Vapor Deposition Equipment for SiC and GaN Sales
Quantity by Type (2027-2032) & (Units)

Table 111. Asia-Pacific Physical Vapor Deposition Equipment for SiC and GaN Sales
Quantity by Application (2021-2026) & (Units)

Table 112. Asia-Pacific Physical Vapor Deposition Equipment for SiC and GaN Sales
Quantity by Application (2027-2032) & (Units)

Table 113. Asia-Pacific Physical Vapor Deposition Equipment for SiC and GaN Sales
Quantity by Region (2021-2026) & (Units)

Table 114. Asia-Pacific Physical Vapor Deposition Equipment for SiC and GaN Sales
Quantity by Region (2027-2032) & (Units)

Table 115. Asia-Pacific Physical Vapor Deposition Equipment for SiC and GaN
Consumption Value by Region (2021-2026) & (USD Million)

Table 116. Asia-Pacific Physical Vapor Deposition Equipment for SiC and GaN
Consumption Value by Region (2027-2032) & (USD Million)

Table 117. South America Physical Vapor Deposition Equipment for SiC and GaN Sales
Quantity by Type (2021-2026) & (Units)

Table 118. South America Physical Vapor Deposition Equipment for SiC and GaN Sales
Quantity by Type (2027-2032) & (Units)

Table 119. South America Physical Vapor Deposition Equipment for SiC and GaN Sales
Quantity by Application (2021-2026) & (Units)

Table 120. South America Physical Vapor Deposition Equipment for SiC and GaN Sales
Quantity by Application (2027-2032) & (Units)

Table 121. South America Physical Vapor Deposition Equipment for SiC and GaN Sales
Quantity by Country (2021-2026) & (Units)

Table 122. South America Physical Vapor Deposition Equipment for SiC and GaN Sales
Quantity by Country (2027-2032) & (Units)

Table 123. South America Physical Vapor Deposition Equipment for SiC and GaN
Consumption Value by Country (2021-2026) & (USD Million)

Table 124. South America Physical Vapor Deposition Equipment for SiC and GaN
Consumption Value by Country (2027-2032) & (USD Million)

Table 125. Middle East & Africa Physical Vapor Deposition Equipment for SiC and GaN

Sales Quantity by Type (2021-2026) & (Units)

Table 126. Middle East & Africa Physical Vapor Deposition Equipment for SiC and GaN

Sales Quantity by Type (2027-2032) & (Units)

Table 127. Middle East & Africa Physical Vapor Deposition Equipment for SiC and GaN

Sales Quantity by Application (2021-2026) & (Units)

Table 128. Middle East & Africa Physical Vapor Deposition Equipment for SiC and GaN

Sales Quantity by Application (2027-2032) & (Units)

Table 129. Middle East & Africa Physical Vapor Deposition Equipment for SiC and GaN

Sales Quantity by Country (2021-2026) & (Units)

Table 130. Middle East & Africa Physical Vapor Deposition Equipment for SiC and GaN

Sales Quantity by Country (2027-2032) & (Units)

Table 131. Middle East & Africa Physical Vapor Deposition Equipment for SiC and GaN

Consumption Value by Country (2021-2026) & (USD Million)

Table 132. Middle East & Africa Physical Vapor Deposition Equipment for SiC and GaN

Consumption Value by Country (2027-2032) & (USD Million)

Table 133. Physical Vapor Deposition Equipment for SiC and GaN Raw Material

Table 134. Key Manufacturers of Physical Vapor Deposition Equipment for SiC and GaN Raw Materials

Table 135. Physical Vapor Deposition Equipment for SiC and GaN Typical Distributors

Table 136. Physical Vapor Deposition Equipment for SiC and GaN Typical Customers

List Of Figures

LIST OF FIGURES

- Figure 1. Physical Vapor Deposition Equipment for SiC and GaN Picture
- Figure 2. Global Physical Vapor Deposition Equipment for SiC and GaN Revenue by Type, (USD Million), 2021 & 2025 & 2032
- Figure 3. Global Physical Vapor Deposition Equipment for SiC and GaN Revenue Market Share by Type in 2025
- Figure 4. Magnetron Sputtering Systems Examples
- Figure 5. Evaporation PVD Systems Examples
- Figure 6. Ion-Beam and HiPIMS Systems Examples
- Figure 7. Hybrid PVD Systems Examples
- Figure 8. Others Examples
- Figure 9. Global Physical Vapor Deposition Equipment for SiC and GaN Revenue by Wafer Size, (USD Million), 2021 & 2025 & 2032
- Figure 10. Global Physical Vapor Deposition Equipment for SiC and GaN Revenue Market Share by Wafer Size in 2025
- Figure 11. Wafer Size 150 mm and Below Examples
- Figure 12. 200 mm Wafer Systems Examples
- Figure 13. 300 mm Wafer Systems Examples
- Figure 14. Multi-Size Flexible Systems Examples
- Figure 15. Others Examples
- Figure 16. Global Physical Vapor Deposition Equipment for SiC and GaN Revenue by Structure, (USD Million), 2021 & 2025 & 2032
- Figure 17. Global Physical Vapor Deposition Equipment for SiC and GaN Revenue Market Share by Structure in 2025
- Figure 18. Cluster PVD Systems Examples
- Figure 19. Standalone PVD Systems Examples
- Figure 20. In-Line PVD Systems Examples
- Figure 21. Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value by Application, (USD Million), 2021 & 2025 & 2032
- Figure 22. Global Physical Vapor Deposition Equipment for SiC and GaN Revenue Market Share by Application in 2025
- Figure 23. SiC Devices Examples
- Figure 24. GaN Devices Examples
- Figure 25. Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value, (USD Million): 2021 & 2025 & 2032
- Figure 26. Global Physical Vapor Deposition Equipment for SiC and GaN Consumption

Value and Forecast (2021-2032) & (USD Million)

Figure 27. Global Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity (2021-2032) & (Units)

Figure 28. Global Physical Vapor Deposition Equipment for SiC and GaN Price (2021-2032) & (K US\$/Unit)

Figure 29. Global Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity Market Share by Manufacturer in 2025

Figure 30. Global Physical Vapor Deposition Equipment for SiC and GaN Revenue Market Share by Manufacturer in 2025

Figure 31. Producer Shipments of Physical Vapor Deposition Equipment for SiC and GaN by Manufacturer Sales (\$MM) and Market Share (%): 2025

Figure 32. Top 3 Physical Vapor Deposition Equipment for SiC and GaN Manufacturer (Revenue) Market Share in 2025

Figure 33. Top 6 Physical Vapor Deposition Equipment for SiC and GaN Manufacturer (Revenue) Market Share in 2025

Figure 34. Global Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity Market Share by Region (2021-2032)

Figure 35. Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value Market Share by Region (2021-2032)

Figure 36. North America Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 37. Europe Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 38. Asia-Pacific Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 39. South America Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 40. Middle East & Africa Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 41. Global Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity Market Share by Type (2021-2032)

Figure 42. Global Physical Vapor Deposition Equipment for SiC and GaN Consumption Value Market Share by Type (2021-2032)

Figure 43. Global Physical Vapor Deposition Equipment for SiC and GaN Average Price by Type (2021-2032) & (K US\$/Unit)

Figure 44. Global Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity Market Share by Application (2021-2032)

Figure 45. Global Physical Vapor Deposition Equipment for SiC and GaN Revenue Market Share by Application (2021-2032)

Figure 46. Global Physical Vapor Deposition Equipment for SiC and GaN Average Price by Application (2021-2032) & (K US\$/Unit)

Figure 47. North America Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity Market Share by Type (2021-2032)

Figure 48. North America Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity Market Share by Application (2021-2032)

Figure 49. North America Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity Market Share by Country (2021-2032)

Figure 50. North America Physical Vapor Deposition Equipment for SiC and GaN Consumption Value Market Share by Country (2021-2032)

Figure 51. United States Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 52. Canada Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 53. Mexico Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 54. Europe Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity Market Share by Type (2021-2032)

Figure 55. Europe Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity Market Share by Application (2021-2032)

Figure 56. Europe Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity Market Share by Country (2021-2032)

Figure 57. Europe Physical Vapor Deposition Equipment for SiC and GaN Consumption Value Market Share by Country (2021-2032)

Figure 58. Germany Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 59. France Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 60. United Kingdom Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 61. Russia Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 62. Italy Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 63. Asia-Pacific Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity Market Share by Type (2021-2032)

Figure 64. Asia-Pacific Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity Market Share by Application (2021-2032)

Figure 65. Asia-Pacific Physical Vapor Deposition Equipment for SiC and GaN Sales

Quantity Market Share by Region (2021-2032)

Figure 66. Asia-Pacific Physical Vapor Deposition Equipment for SiC and GaN

Consumption Value Market Share by Region (2021-2032)

Figure 67. China Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 68. Japan Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 69. South Korea Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 70. India Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 71. Southeast Asia Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 72. Australia Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 73. South America Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity Market Share by Type (2021-2032)

Figure 74. South America Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity Market Share by Application (2021-2032)

Figure 75. South America Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity Market Share by Country (2021-2032)

Figure 76. South America Physical Vapor Deposition Equipment for SiC and GaN Consumption Value Market Share by Country (2021-2032)

Figure 77. Brazil Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 78. Argentina Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 79. Middle East & Africa Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity Market Share by Type (2021-2032)

Figure 80. Middle East & Africa Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity Market Share by Application (2021-2032)

Figure 81. Middle East & Africa Physical Vapor Deposition Equipment for SiC and GaN Sales Quantity Market Share by Country (2021-2032)

Figure 82. Middle East & Africa Physical Vapor Deposition Equipment for SiC and GaN Consumption Value Market Share by Country (2021-2032)

Figure 83. Turkey Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 84. Egypt Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 85. Saudi Arabia Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 86. South Africa Physical Vapor Deposition Equipment for SiC and GaN Consumption Value (2021-2032) & (USD Million)

Figure 87. Physical Vapor Deposition Equipment for SiC and GaN Market Drivers

Figure 88. Physical Vapor Deposition Equipment for SiC and GaN Market Restraints

Figure 89. Physical Vapor Deposition Equipment for SiC and GaN Market Trends

Figure 90. Porters Five Forces Analysis

Figure 91. Manufacturing Cost Structure Analysis of Physical Vapor Deposition Equipment for SiC and GaN in 2025

Figure 92. Manufacturing Process Analysis of Physical Vapor Deposition Equipment for SiC and GaN

Figure 93. Physical Vapor Deposition Equipment for SiC and GaN Industrial Chain

Figure 94. Sales Channel: Direct to End-User vs Distributors

Figure 95. Direct Channel Pros & Cons

Figure 96. Indirect Channel Pros & Cons

Figure 97. Methodology

Figure 98. Research Process and Data Source

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